30V P-Channel Trench Power MOSFET

General Description

The SJP4407 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as -4.5V. This device is suitable for use as a wide variety of applications.

Features

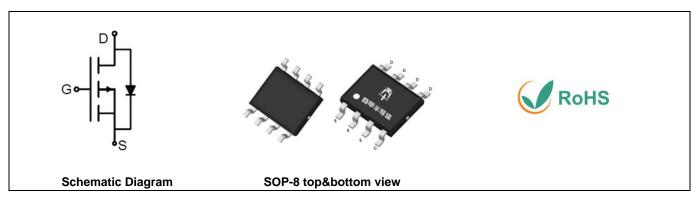
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

- PWM Applications
- Load Switch
- Power Management

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	-30	V
R _{DS(ON)_TYP}	8.6	mΩ
I _D	-16	Α
Q _G	59	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJP4407	SJP4407	SOP-8	Tape	\	\	4000 Pcs

Table 1. Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	-30	V
V _{GS}	Gate-Source Voltage (V _{DS} =0V)	±20	V
1	Drain Current-Continuous(T _A =25°C)		А
I _D	Drain Current-Continuous(T _A =100°C)	-9.9	А
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-62.4	А
D	Maximum Power Dissipation(T _A =25°C)	4.4	W
P _D	Maximum Power Dissipation(T _A =100°C)	1.7	W
Eas	Avalanche energy (Note 2)	182	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
R _{θJA} Thermal Resistance, Junction-to-Ambient			28.6	°C/W



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Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250μA	-30			V
		V _{DS} =-30V, V _{GS} =0V T _J =25°C			-1	μΑ
loss	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V T _J =125°C			-100	μΑ
Igss	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1		-2.5	V
g FS	Forward Transconductance	V _{DS} =-5V, I _D =-15A		38		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-15A T _J =25°C		8.6	11.2	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-10A T _J =25°C		11.7	15.6	mΩ
Dynamic Chara	cteristics	,		•		•
Ciss	Input Capacitance			2109		pF
Coss	Output Capacitance	V _{DS} =-15V,V _{GS} =0V, f=1.0MHz		270		pF
Crss	Reverse Transfer Capacitance			202		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		13.5		Ω
Switching Para	meters					•
t _{d(on)}	Turn-on Delay Time			7		nS
t _r	Turn-on Rise Time	V _{GS} =-10V, V _{DS} =-15V,		6		nS
t _{d(off)}	Turn-Off Delay Time	$R_L=1\Omega$, $R_{GEN}=3\Omega$		112		nS
t _f	Turn-Off Fall Time			78		nS
Qg	Total Gate Charge			59		nC
Q _{gs}	Gate-Source Charge	V _{GS} =-10V, V _{DS} =-15V, I _D =-15A		10		nC
Q_{gd}	Gate-Drain Charge			14		nC
Source-Drain Diode Characteristics						
I _{SD}	Source-Drain Current (Body Diode)				-16	Α
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =-15A			-1.2	V
t _{rr}	Reverse Recovery Time	I _F =-15A, dI/dt=100A/μs		21		ns
Qrr	Reverse Recovery Charge	I _F =-15A, dI/dt=100A/μs		10		nC

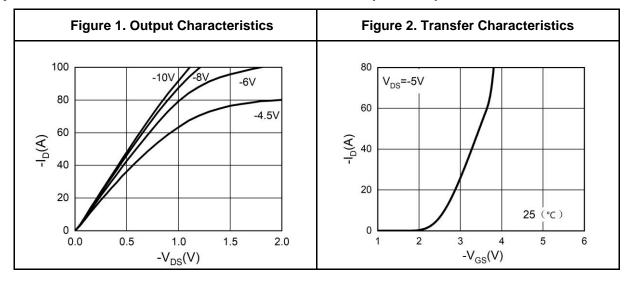
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

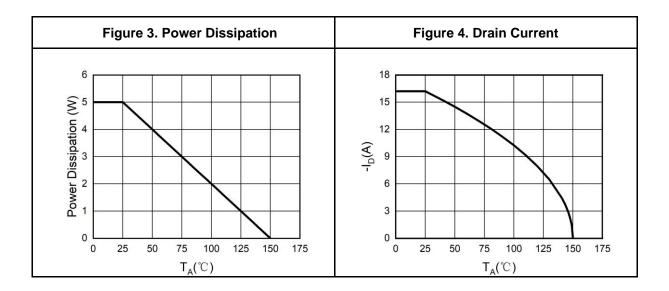
Notes 2.E_{AS} condition: $T_J=25^{\circ}C$, $V_{DD}=-30V$, $V_{G}=-10V$, $Rg=25\Omega$, L=0.5mH.

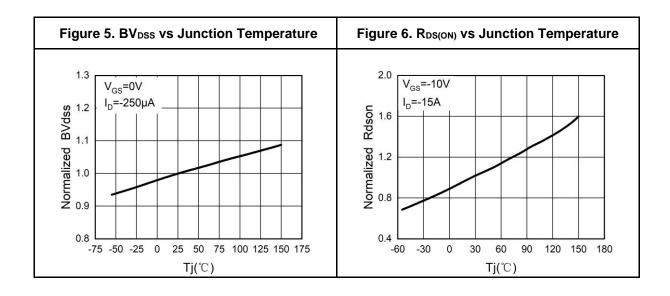
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Typical Electrical And Thermal Characteristics (Curves)

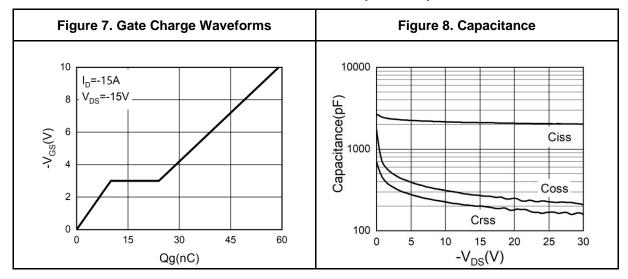


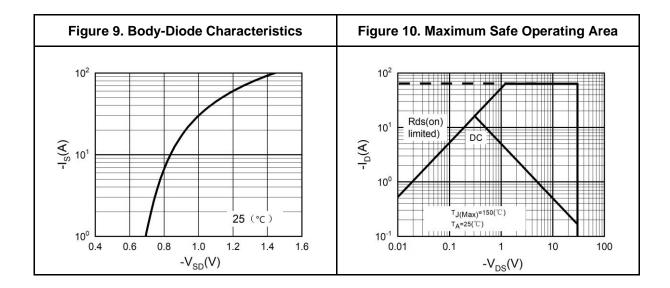






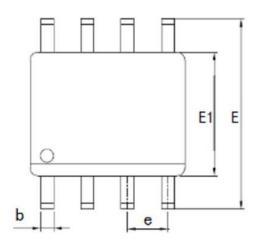
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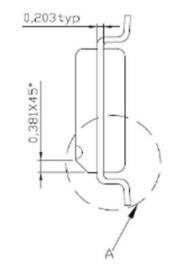


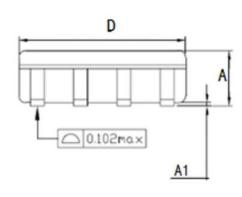


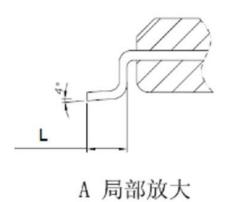


SOP-8 Package Information









	Dime	nsions In Millimeters		
Symbol	Min.	Nom.	Max	
А	1.35	1.55	1.75	
A1	0.1	0.15	0.2	
b	0.346	0.406	0.466	
D	4.8	4.89	4.98	
E	5.75	6.00	6.25	
E1	3.81	3.90	3.99	
е	1.27TYP			
L	0.406	0.838	1.27	



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